# 

### Silicon Carbide Power Schottky Diode

#### Features

- Industry's leading low leakage currents
- 175 °C maximum operating temperature
- Temperature independent switching behavior
- Superior surge current capability
- Positive temperature coefficient of V<sub>F</sub>
- Extremely fast switching speeds
- Superior figure of merit  $Q_C/I_F$

### Advantages

- Low standby power losses
- Improved circuit efficiency (Lower overall cost)
- Low switching losses
- · Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- Low reverse recovery current
- Low device capacitance
- Low reverse leakage current at operating temperature

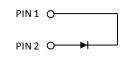
## GB01SLT12-214

V <sub>RRM</sub>	=	1200 V
I <sub>F (Tc = 25°C)</sub>	=	2.5 A
I <sub>F (Tc ≤ 150°C)</sub>	=	1 A
Qc	=	7 nC

#### Package

RoHS Compliant





#### SMB / DO - 214AA

#### Applications

- Power Factor Correction (PFC)
- Switched-Mode Power Supply (SMPS)
- Solar Inverters
- Wind Turbine Inverters
- Motor Drives
- Induction Heating
- Uninterruptible Power Supply (UPS)
- High Voltage Multipliers

#### Maximum Ratings at T<sub>j</sub> = 175 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit	
Repetitive peak reverse voltage	V <sub>RRM</sub>		1200	V	
Continuous forward current	l <sub>F</sub>	T <sub>C</sub> = 25 °C	2.5	А	
Continuous forward current	I <sub>F</sub>	T <sub>C</sub> ≤ 150 °C	1	А	
RMS forward current	I <sub>F(RMS)</sub>	T <sub>C</sub> ≤ 150 °C	2	А	
Surge non-repetitive forward current, Half Sine		$T_{C} = 25 \text{ °C}, t_{P} = 10 \text{ ms}$	10	^	
Wave	I <sub>F,SM</sub>	$T_{C}$ = 150 °C, $t_{P}$ = 10 ms	8	A	
Non-repetitive peak forward current	I <sub>F,max</sub>	$T_{C} = 25 \text{ °C}, t_{P} = 10 \ \mu s$	65	А	
l <sup>2</sup> t value	∫i² dt	$T_{C} = 25 \text{ °C}, t_{P} = 10 \text{ ms}$	0.5	A <sup>2</sup> s	
i t value	ji dt	$T_{C}$ = 150 °C, $t_{P}$ = 10 ms	0.3		
Power dissipation	P <sub>tot</sub>	T <sub>C</sub> = 25 °C	42	W	
Operating and storage temperature	T <sub>i</sub> , T <sub>stg</sub>		-55 to 175	°C	

#### Electrical Characteristics at T<sub>j</sub> = 175 °C, unless otherwise specified

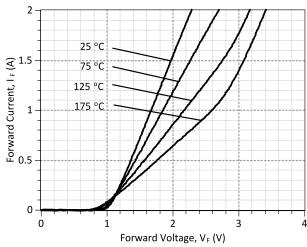
Devementer	Symphol	Conditions m		Values		L Incit	
Parameter	Symbol			min.	typ.	max.	Unit
Diode forward voltage	VF	$I_F = 1 A, T_j = 2$			1.6	1.8	V
	- 1	$I_F = 1 A, T_j = 17$	I <sub>F</sub> = 1 A, T <sub>j</sub> = 175 °C		2.4	3.7	•
Reverse current	1	V <sub>R</sub> = 1200 V, T <sub>j</sub> = 25 °C		5	10	μΑ	
	I <sub>R</sub>	V <sub>R</sub> = 1200 V, T <sub>j</sub> = 175 °C			10		100
Total capacitive charge	Q <sub>c</sub>		$V_{R} = 400 V$		7 13		nC
		$I_F \leq I_{F,MAX}$	V <sub>R</sub> = 960 V				
Switching time	t <sub>s</sub>	dl <sub>F</sub> /dt = 200 A/µs T₁ = 175 °C	V <sub>R</sub> = 400 V		. 47		20
		$V_{R} = 960 V$			< 17		ns
		V <sub>R</sub> = 1 V, f = 1 MHz,	T <sub>j</sub> = 25 °C		69		
Total capacitance	С	V <sub>R</sub> = 400 V, f = 1 MHz, T <sub>i</sub> = 25 °C		10		pF	
		V <sub>R</sub> = 1000 V, f = 1 MHz, T <sub>i</sub> = 25 °C			8		-

#### Thermal Characteristics

Thermal resistance, junction - case	R <sub>thJC</sub>	3.6	°C/W

# **Jenes**

## GB01SLT12-214





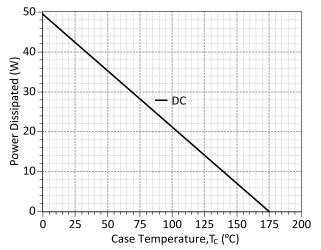


Figure 3: Power Derating Curve

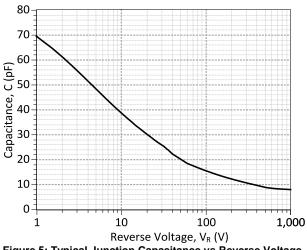


Figure 5: Typical Junction Capacitance vs Reverse Voltage Characteristics

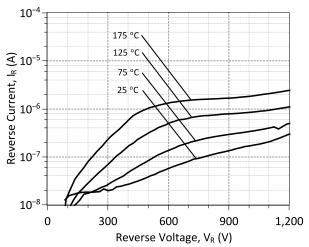
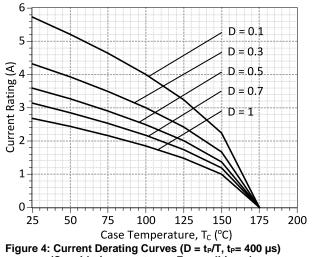
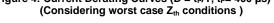
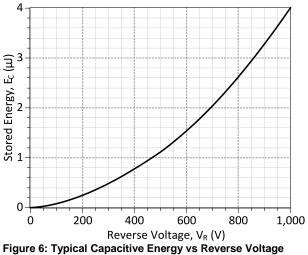


Figure 2: Typical Reverse Characteristics

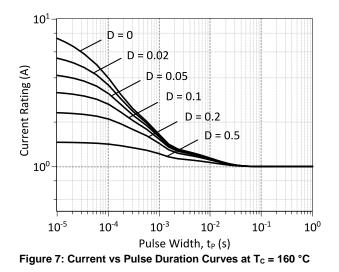




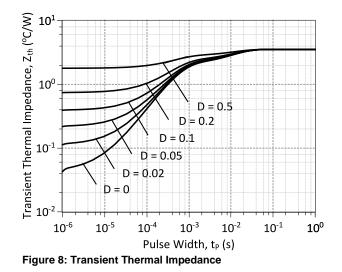


Characteristics

## GB01SLT12-214



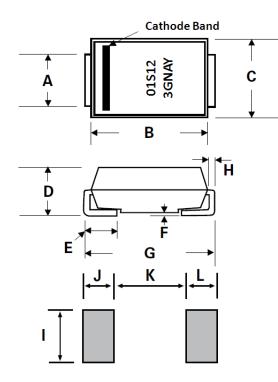
Genes E M I C O N D U C



#### **Package Dimensions:**

SMB / DO-214AA

#### PACKAGE OUTLINE



Dimensions	Inches Min Max		Millin	imeters	
Dimensions			Min	Max	
А	0.077	0.086	1.950	2.200	
В	0.160	0.180	4.060	4.570	
С	0.130	0.155	3.300	3.940	
D	0.084	0.096	2.130	2.440	
E	0.030	0.060	0.760	1.520	
F	-	0.008	-	0.203	
G	0.205	0.220	5.210	5.590	
Н	0.006	0.012	0.152	0.305	
l.	0.089	-	2.260	-	
J	0.085	-	2.160	-	
К	-	0.107	-	2.740	
L	0.085	-	2.160	-	

#### NOTE

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER. 2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS



## GB01SLT12-214

Revision History					
Date	Revision	Comments	Supersedes		
2014/08/26	1	Updated Electrical Characteristics			
2013/09/09	0	Initial release			

Published by GeneSiC Semiconductor, Inc. 43670 Trade Center Place Suite 155 Dulles, VA 20166

GeneSiC Semiconductor, Inc. reserves right to make changes to the product specifications and data in this document without notice.

GeneSiC disclaims all and any warranty and liability arising out of use or application of any product. No license, express or implied to any intellectual property rights is granted by this document.

Unless otherwise expressly indicated, GeneSiC products are not designed, tested or authorized for use in life-saving, medical, aircraft navigation, communication, air traffic control and weapons systems, nor in applications where their failure may result in death, personal injury and/or property damage.



# 

### **SPICE Model Parameters**

This is a secure document. Please copy this code from the SPICE model PDF file on our website (http://www.genesicsemi.com/images/products\_sic/rectifiers/GB01SLT12-214\_SPICE.pdf) into LTSPICE (version 4) software for simulation of the GB01SLT12-214.

```
MODEL OF GeneSiC Semiconductor Inc.
*
*
     $Revision: 1.0
                                 $
*
     $Date: 09-SEP-2013
                                 $
*
*
     GeneSiC Semiconductor Inc.
*
     43670 Trade Center Place Ste. 155
     Dulles, VA 20166
*
*
*
     COPYRIGHT (C) 2013 GeneSiC Semiconductor Inc.
*
     ALL RIGHTS RESERVED
*
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
 Models accurate up to 2 times rated drain current.
*
*
 Start of GB01SLT12-214 SPICE Model
.SUBCKT GB01SLT12 ANODE KATHODE
R1 ANODE INT R=((TEMP-24) *0.0069); Temperature Dependant Resistor
D1 INT KATHODE GB01SLT12 25C; Call the 25C Diode Model
D2 ANODE KATHODE GB01SLT12 PIN; Call the PiN Diode Model
.MODEL GB01SLT12 25C D
+ IS
           7.27E-19
                                       0.592251
                            RS
+ N
          1
                           IKF
                                       407.773
+ EG
           1.2
                            XTI
                                       3
                                       0.367
          7.90E-11
+ CJO
                           VJ
+ M
          1.63
                           FC
                                       0.5
+ TT
           1.00E-10
                           ΒV
                                       1200
          1.00E-03
+ IBV
                           VPK
                                       1200
+ IAVE
                                       SiC Schottky
           1
                            TYPE
+ MFG
          GeneSiC Semiconductor
.MODEL GB01SLT12 PIN D
           1.08E-17
+ IS
                            RS
                                       1.8
+ N
           2.2313
                           IKF
                                       999
+ EG
          3.23
                           XTI
                                       -65
          0.5
                            TT
+ FC
                                       0
+ BV
          1200
                           IBV
                                       1.00E-03
+ VPK
           1200
                            IAVE
                                       1
+ TYPE
           SiC PiN
.ENDS
* End of GB01SLT12-214 SPICE Model
```